

N-Channel Super Junction Power MOSFET $\ensuremath{\,\mathrm{IV}}$

General Description

The series of devices use advanced trench gate super junction technology and design to provide excellent R_{DS(ON)} with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

Features

- Optimized body diode reverse recovery performance
- ●Low on-resistance and low conduction losses
- Small package
- ●Ultra Low Gate Charge cause lower driving requirements
- ●100% Avalanche Tested
- ●ROHS compliant

Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)
- LLC Half-bridge

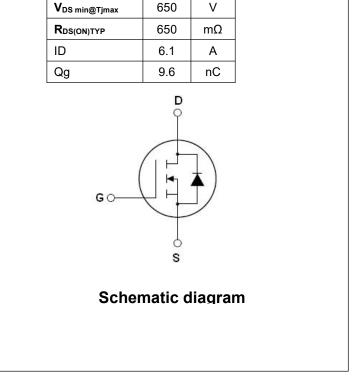
Package Marking And Ordering Information

Device	Device Package	Marking
NCE60N700R	SOT-223-2L	NCE60N700R

Table 1. Absolute Maximum Ratings (Tc=25℃)

Parameter	Symbol	Value	Unit
Drain-Source Voltage (VGS=0V)	VDS	600	V
Gate-Source Voltage (VDS=0V) AC (f>1 Hz)	Vgs	±30	V
Gate-Source Voltage (VDS=0V) DC	Vgs	±20	V
Continuous Drain Current at Tc=25°C	I _{D (DC)}	6.1	A
Continuous Drain Current at Tc=100°C	I _{D (DC)}	4.27	A
Pulsed drain current ^(Note 1)	I _{DM (pluse)}	18.3	A
Maximum Power Dissipation(Tc=25°C)	PD	5.2	W
Derate above 25°C		0.03	W/°C
Avalanche current ^(Note 1)	I _{AS}	1.3	A
Drain Source voltage slope, V _{DS} ≤480 V,	dv/dt	50	V/ns
Reverse diode dv/dt, V _{DS} ≤480 V,I _{SD} <i<sub>D</i<sub>	dv/dt	15	V/ns
Operating Junction and Storage Temperature Range	TJ,TSTG	-55+175	°C

 * limited by maximum junction temperature





SOT-223-2L



Table 2. Thermal Characteristic

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Maximum)	R _{thJC}	28.84	°C /W
Thermal Resistance, Junction-to-Ambient (Maximum)	R _{thJA}	62	°C /W

Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
On/off states		· · · · · · · · · · · · · · · · · · ·		•		
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	600			V
Zero Gate Voltage Drain Current(Tc=25°C)	I _{DSS}	V _{DS} =600V,V _{GS} =0V			1	μA
Zero Gate Voltage Drain Current(Tc=125℃)	I _{DSS}	V _{DS} =600V,V _{GS} =0V			100	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V			±200	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	3	3.5	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =3A		650	700	mΩ
Dynamic Characteristics		· · · · ·				
Input Capacitance	Clss			250		pF
Output Capacitance	Coss	V_{DS} =50V, V_{GS} =0V,		21		pF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz		4		pF
Total Gate Charge	Qg			9.6		nC
Gate-Source Charge	Qgs	V _{DS} =450V,I _D =3A,		2.5		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V		3.3		nC
Gate plateau voltage	Vgp			5.5		V
Intrinsic gate resistance	Rg	f = 1 MHz open drain		43		Ω
Switching times	L.	· · · · · ·				
Turn-on Delay Time	t _{d(on)}			11		nS
Turn-on Rise Time	tr	V _{DD} =380V,I _D =3A,		6		nS
Turn-Off Delay Time	t _{d(off)}	R _G =1.7Ω,V _{GS} =10V		26		nS
Turn-Off Fall Time	t _f			10		nS
Source- Drain Diode Characteristics	·					
Source-drain current(Body Diode)	I _{SD}	тоско			6.4	А
Pulsed Source-drain current(Body Diode)	I _{SDM}	T _c =25°C			19.2	Α
Forward On Voltage	V _{SD}	Tj=25°C,I _{SD} =6.1A,V _{GS} =0V		0.9	1.2	V
Reverse Recovery Time	t _{rr}			140		nS
Reverse Recovery Charge	Qrr	Tj=25°C,I⊧=3A,		0.64		uC
Peak Reverse Recovery Current	Irrm	di/dt=100A/µs		9		А

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature

2. Tj=25°C,VDD=50V,VG=10V, R_G=25 Ω



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure1. Safe operating area

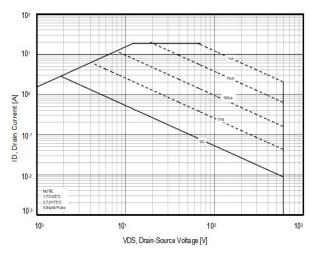


Figure3. Transfer characteristics

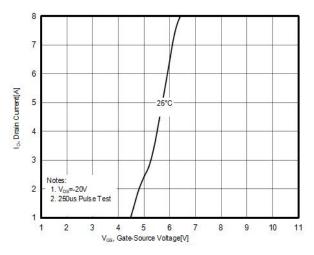


Figure 5. RDS(ON) vs Junction Temperature

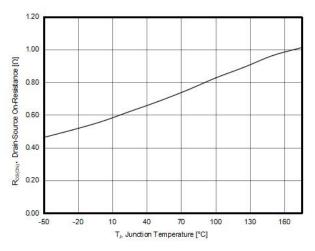


Figure2. Capacitance

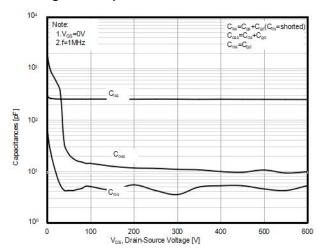


Figure4. Output characteristics

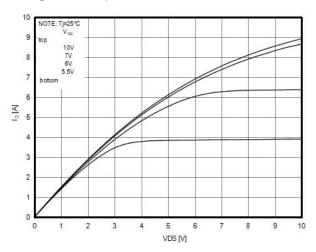
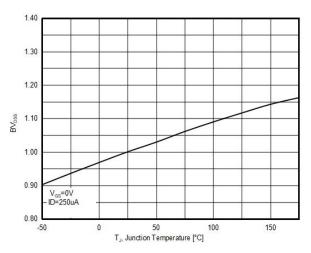


Figure6. BV_{DSS} vs Junction Temperature





NCE60N700R

Figure 7. Maximum I_D vs Junction Temperature

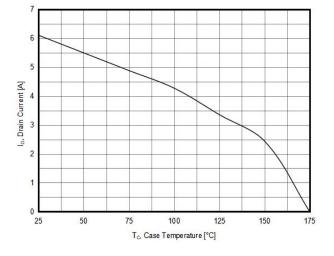


Figure8. Gate charge waveforms

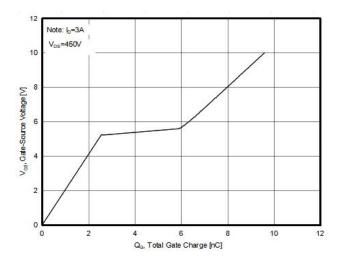


Figure9. Static drain-source on resistance

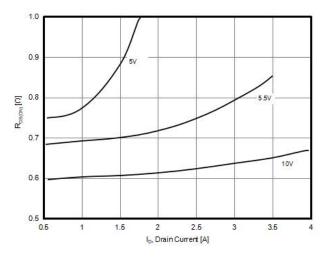
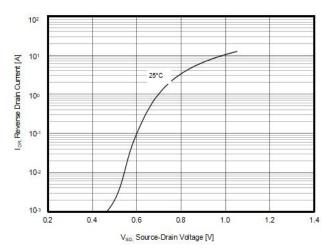


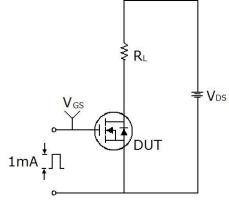
Figure10. Source-Drain Diode Forward Voltage

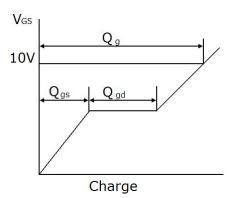




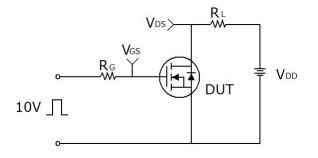
Test circuit

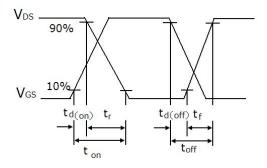
1) Gate charge test circuit & Waveform



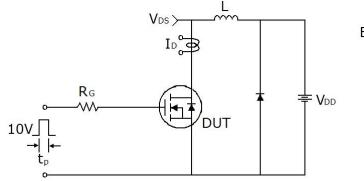


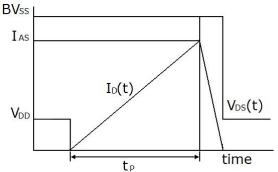
2) Switch Time Test Circuit:





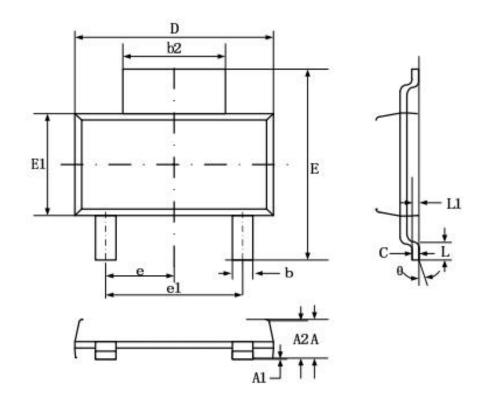
3) Unclamped Inductive Switching Test Circuit & Waveforms







SOT-223-2L-B Package Information



Symbol _	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.	
A		1.80	()()	0.071	
A1	0.02	0.10	0.001	0.004	
A2	1.50	1.70	0.059	0.067	
b	0.66	0.84	0.026	0.033	
b2	2.90	3.1 <mark>0</mark>	0.114	0.122	
С	0.23	0.35	0.009	0.014	
D	6.30	6.70	0.248	0.264	
E	6.70	7.30	0.264	0.287	
E1	3.30	3.70	0.130	0.146	
е	2.30 BSC.		0.091	BSC.	
e1	4.60 BSC.		0.182	BSC.	
L.	0.81		0.032	0-0	



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